HALOGEN

FREE



Vishay Siliconix

Dual N-Channel 30 V (D-S) MOSFETs

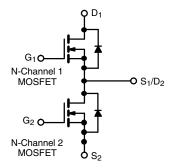
PRODUCT SUMMARY							
	V _{DS} (V)	$R_{DS(on)}(\Omega)$ (Max.)	I _D (A)	Q _g (Typ.)			
Channel-1	30	0.0120 at $V_{GS} = 10 \text{ V}$	16 ^a	6.8 nC			
Channel-1	30	0.0145 at $V_{GS} = 4.5 \text{ V}$	16 ^a	0.0110			
Channel-2	30	0.0064 at V _{GS} = 10 V	16 ^a	21 nC			
Chamer-2	30	0.0083 at $V_{GS} = 4.5 \text{ V}$	16 ^a	21110			

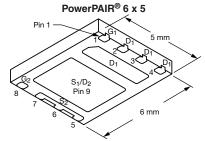
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Notebook System Power
- POL
- Synchronous Buck Converter





Ordering Information: SiZ902DT-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Parameter		Channel-1	Channel-2	Unit	
Drain-Source Voltage		V_{DS}	30		V	
Gate-Source Voltage		V_{GS}	± 20		V	
	T _C = 25 °C		16 ^a	16 ^a		
Continuous Drain Current (T _J = 150 °C)	$T_C = 70 ^{\circ}\text{C}$ $T_A = 25 ^{\circ}\text{C}$	I _D	16 ^a 14.3 ^{b, c}	16 ^a	٨	
	T _A = 70 °C	† -	11.4 ^{b, c}	16 ^{a, b, c}		
Pulsed Drain Current (t = 300 μs)		I _{DM}	50	80	Α	
Continuous Source Drain Diode Current	T _C = 25 °C	la	16 ^a	16 ^a		
Continuous Source Diain Blode Current	$T_A = 25 ^{\circ}C$	- I _S	3.4 ^{b, c}	4.1 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	18	30		
Single Pulse Avalanche Energy		E _{AS}	16	45	mJ	
	$T_C = 25 ^{\circ}C$		29	66	W	
Maximum Power Dissipation	T _C = 70 °C	P_{D}	18	42		
Maximum Tower Dissipation	T _A = 25 °C	ט י	4.2 ^{b, c}	5 ^{b, c}		
	T _A = 70 °C		2.7 ^{b, c}	3.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		- °C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260			

THERMAL RESISTANCE RATING	S						
Parameter			Char	nel-1	Chan	nel-2	
		Symbol	Тур. Мах.		Тур.	Max.	Unit
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	24	30	20	25	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	3.4	4.3	1.5	1.9	J/ VV

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAIR is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 65 °C/W for channel-1 and 57 °C/W for channel-2.

Document Number: 63465 S11-2380 Rev. B, 28-Nov-11

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Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit	
Static					, ,,		l	
		$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	Ch-1	30				
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	Ch-2	30			V	
V. Tama and an Ocalificiant		I _D = 250 μA	Ch-1		33			
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA	Ch-2		33			
V Tamananatura Coefficient		I _D = 250 μA	Ch-1		- 5		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	Ch-2		- 4.6			
Coto Threehold Voltage	\/	$V_{DS} = V_{GS}, I_D = 250 \mu A$	Ch-1	1		2.2	T. ,	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	Ch-2	1		2.2	V	
Gate Source Leakage	loss	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	Ch-1			± 100	r 1	
date Source Leakage	I _{GSS}		Ch-2			± 100	ш	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-1			1	μΑ	
Zero Gate Voltage Drain Current	Inno	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-2			1		
	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 ^{\circ}\text{C}$	Ch-1			5		
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	Ch-2			5	1	
0 0: 1 D : 0 1h		$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	Ch-1	20			Λ.	
On-State Drain Current ^D	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	Ch-2	20			A	
		$V_{GS} = 10 \text{ V}, I_D = 13.8 \text{ A}$	Ch-1		0.010	0.012	A 0.012 0.0064 0.0145 Ω	
		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	Ch-2		0.0053	0.0064		
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 12.6 \text{ A}$	Ch-1		0.0120	0.0145	Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	Ch-2		0.0068	0.0083		
b	_	$V_{DS} = 10 \text{ V}, I_D = 13.8 \text{ A}$	Ch-1		47		_	
Forward Transconductance ^b	9 _{fs}	$V_{DS} = 10 \text{ V}, I_D = 20 \text{ A}$	Ch-2		63		S	
Dynamic ^a				L	•		L	
Innut Conscitones			Ch-1		790			
Input Capacitance	C _{iss}	Channel-1	Ch-2		2600			
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	Ch-1		190		пF	
Output Capacitance	Joss	Channel-2	Ch-2		485		- рг -	
Reverse Transfer Capacitance	C _{rss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	Ch-1		76			
	.00	V 45 V V 40 V L 40 0 A	Ch-2		215			
		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13.8 \text{ A}$	Ch-1		14	21	2	
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	Ch-2		43	65		
		Channel-1	Ch-1		6.8	11		
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 13.8 \text{ A}$	Ch-2		21	32	nC	
Gate-Source Charge	Q_{gs}		Ch-1 Ch-2		2.6		4	
		Channel-2	Ch-1		8.1 1.9			
Gate-Drain Charge	Q_{gd}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$			6.5			
		+		0.4	2	4		
Gate Resistance	R_g	f = 1 MHz	Ch-1 Ch-2	0.3	1.5	3	Ω	

Notes:

a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.



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Parameter	Symbol Test Conditions			Min.	Тур.	Max.	Unit
Dynamic ^a							
Turn-On Delay Time	t _{d(on)}	Channel-1	Ch-1		15	30	
<u> </u>	- (- /	$V_{DD} = 15 \text{ V}, R_{I} = 1.5 \Omega$	Ch-2		23	50	
Rise Time	t _r	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	Ch-1 Ch-2		12 20	20 40	
			Ch-1		20	40	
Turn-Off Delay Time	t _{d(off)}	Channel-2 $V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$	Ch-2		35	70	
		$I_{D} \cong 10 \text{ A, } V_{GEN} = 4.5 \text{ V, } R_{q} = 1 \Omega$	Ch-1		10	20	
Fall Time	t _f	B = 101, 1GEN 110 1, 1.g	Ch-2		10	20	
Tire On Delay Time	+		Ch-1		10	20	ns
Turn-On Delay Time	t _{d(on)}	Channel-1	Ch-2		22	25	
Rise Time		$V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega$	Ch-1		12	20	
nise Time	t _r	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	Ch-2		10	20	
Turn-Off Delay Time	n-Off Delay Time t _{d(off)} Channel-2		Ch-1		20	40	
Tarri On Boldy Time	*u(oii)	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$	Ch-2		35	70	
Fall Time	t _f	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	Ch-1		10	20	
	·		Ch-2		10	20	
Drain-Source Body Diode Characteristi	cs		T	ı	1	1	T
Continuous Source-Drain Diode Current	Is	T _C = 25 °C	Ch-1			16	
			Ch-2			16	Α
Pulse Diode Forward Current ^a	I _{SM}		Ch-1 Ch-2			50 80	
		I _S = 10 A, V _{GS} = 0 V	Ch-1		0.85	1.2	
Body Diode Voltage	V_{SD}	I _S = 10 A, V _{GS} = 0 V	Ch-2		0.8	1.2	V
		3 - 7 43 -	Ch-1		20	40	
Body Diode Reverse Recovery Time	t _{rr}		Ch-2		25	50	ns
		Channel-1	Ch-1		10	20	_
Body Diode Reverse Recovery Charge	Q_{rr}	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	Ch-2		13	25	nC
Deverage December Fell Times		Channel-2	Ch-1		11		
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	Ch-2		12		nc
Payarea Pagayary Piga Tima	+.		Ch-1		9		ns
Reverse Recovery Rise Time	t _b		Ch-2		13		1

Notes:

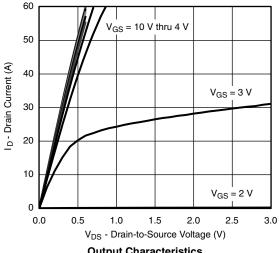
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Guaranteed by design, not subject to production testing.

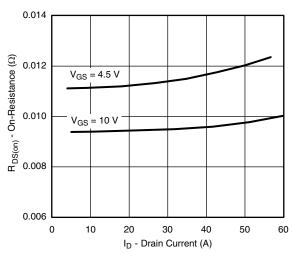
b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

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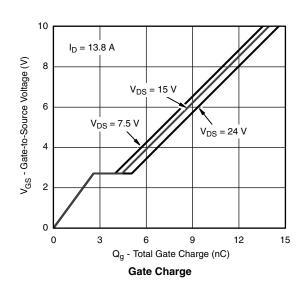
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

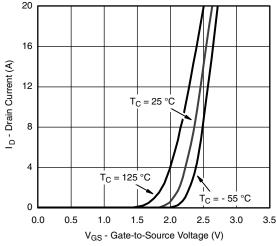




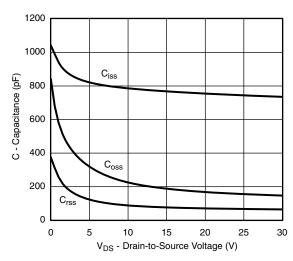


On-Resistance vs. Drain Current

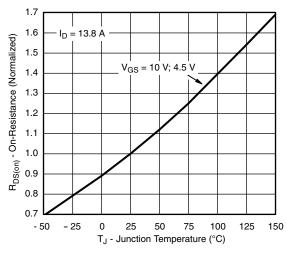




Transfer Characteristics



Capacitance

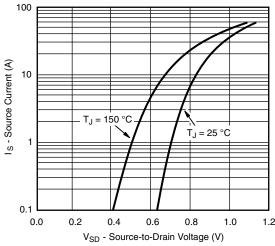


On-Resistance vs. Junction Temperature

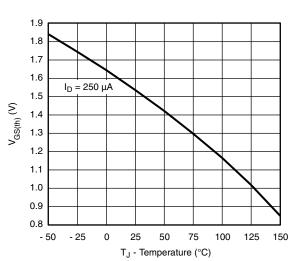


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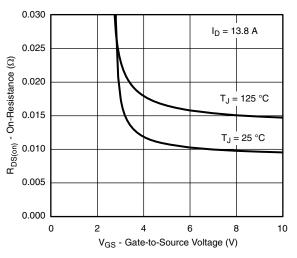
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



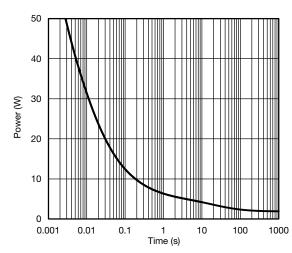
Source-Drain Diode Forward Voltage



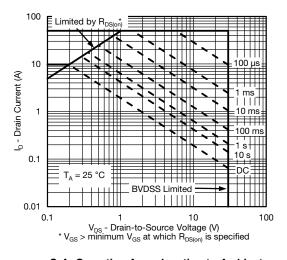
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power

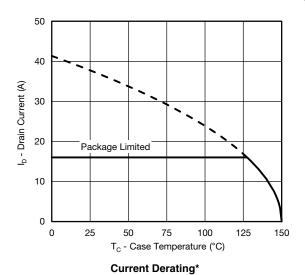


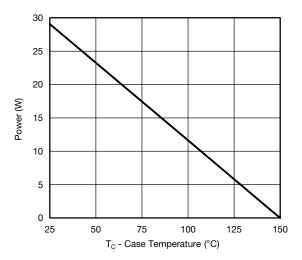
Safe Operating Area, Junction-to-Ambient

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CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





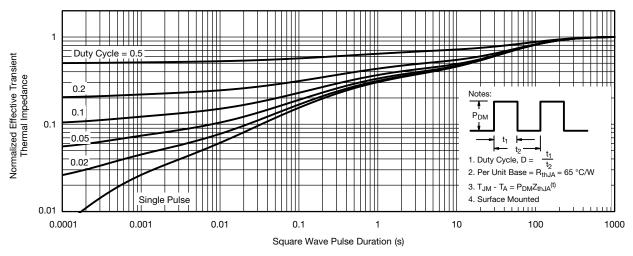
Power, Junction-to-Case

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

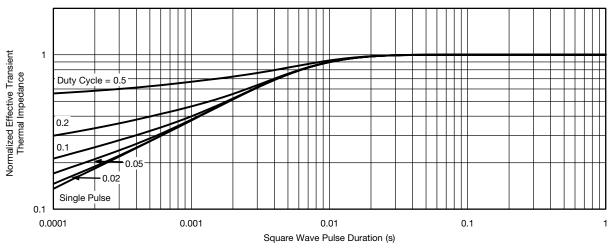


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CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

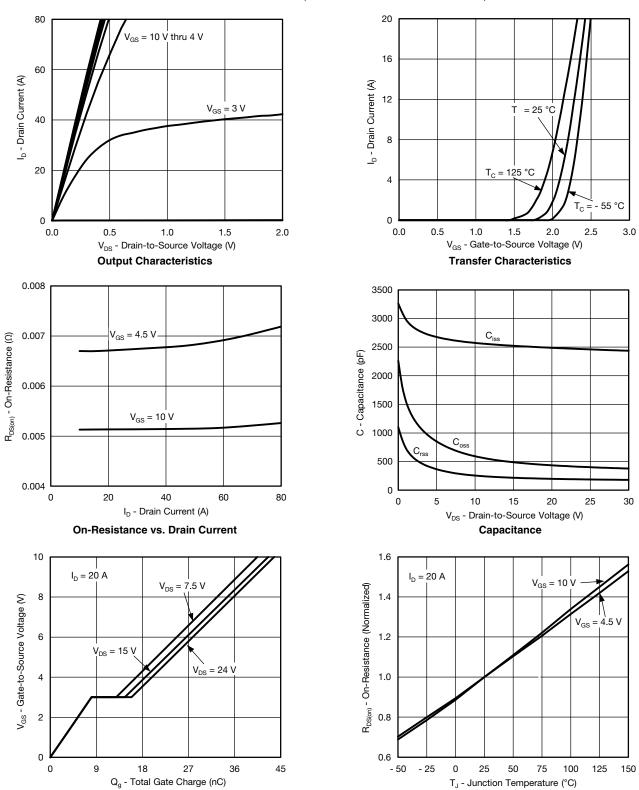


Normalized Thermal Transient Impedance, Junction-to-Case

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CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Gate Charge

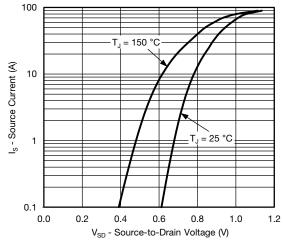
On-Resistance vs. Junction Temperature

0.016

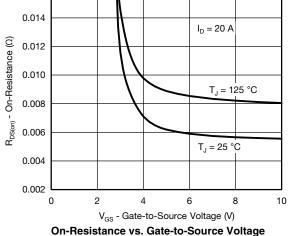


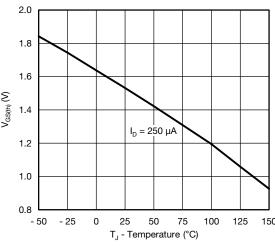
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CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

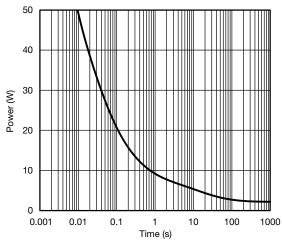


Source-Drain Diode Forward Voltage

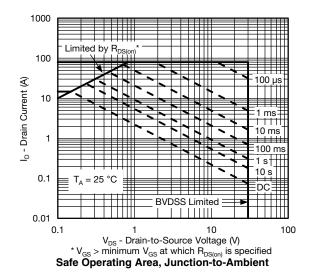




Threshold Voltage



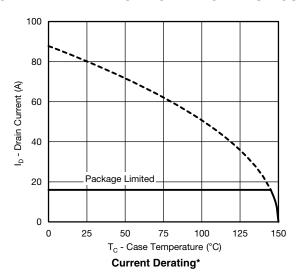
Single Pulse Power

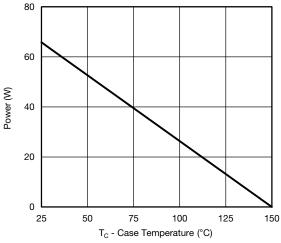


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CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





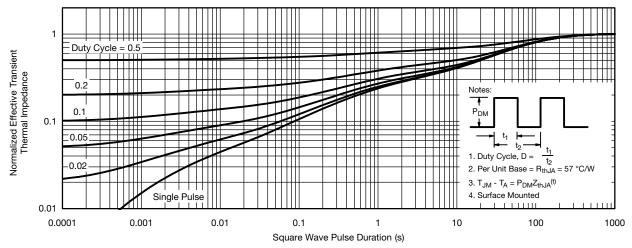
Power, Junction-to-Case

^{*} The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

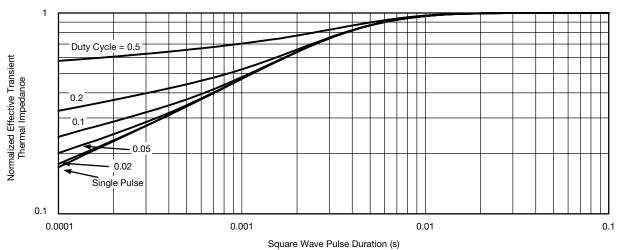


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CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



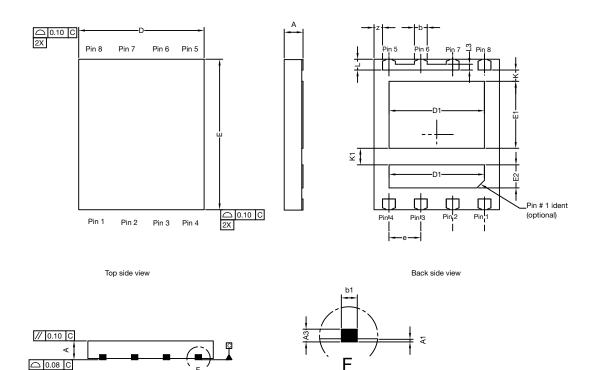
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63465.

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PowerPAIR® 6 x 5 Case Outline

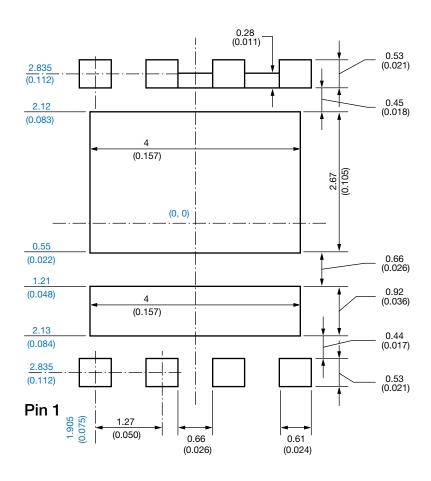


		MILLIMETERS		INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.70	0.75	0.80	0.028	0.030	0.032	
A1	0.00	-	0.10	0.000	-	0.004	
A3	0.15	0.20	0.25	0.006	0.007	0.009	
b	0.43	0.51	0.61	0.017	0.020	0.024	
b1		0.25 BSC			0.010 BSC		
D	4.90	5.00	5.10	0.192	0.196	0.200	
D1	3.75	3.80	3.85	0.148	0.150	0.152	
Е	5.90	6.00	6.10	0.232	0.236	0.240	
E1 Option AA (for W/B)	2.62	2.67	2.72	0.103	0.105	0.107	
E1 Option AB (for BWL)	2.42	2.47	2.52	0.095	0.097	0.099	
E2	0.87	0.92	0.97	0.034	0.036	0.038	
е		1.27 BSC		0.050 BSC			
K Option AA (for W/B)	0.45 typ.			0.018 typ.			
K Option AB (for BWL)	0.65 typ.			0.025 typ.			
K1	0.66 typ. 0.025 typ.				0.025 typ.		
L	0.33	0.43	0.53	0.013	0.017	0.020	
L3		0.23 BSC		0.009 BSC			
Z	0.34 BSC			0.013 BSC			

Revision: 22-Dec-14 1 Document Number: 63656



Recommended Minimum PAD for PowerPAIR® 6 x 5



Dimensions in millimeters (inch)

Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



Legal Disclaimer Notice

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Disclaimer

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Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000

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